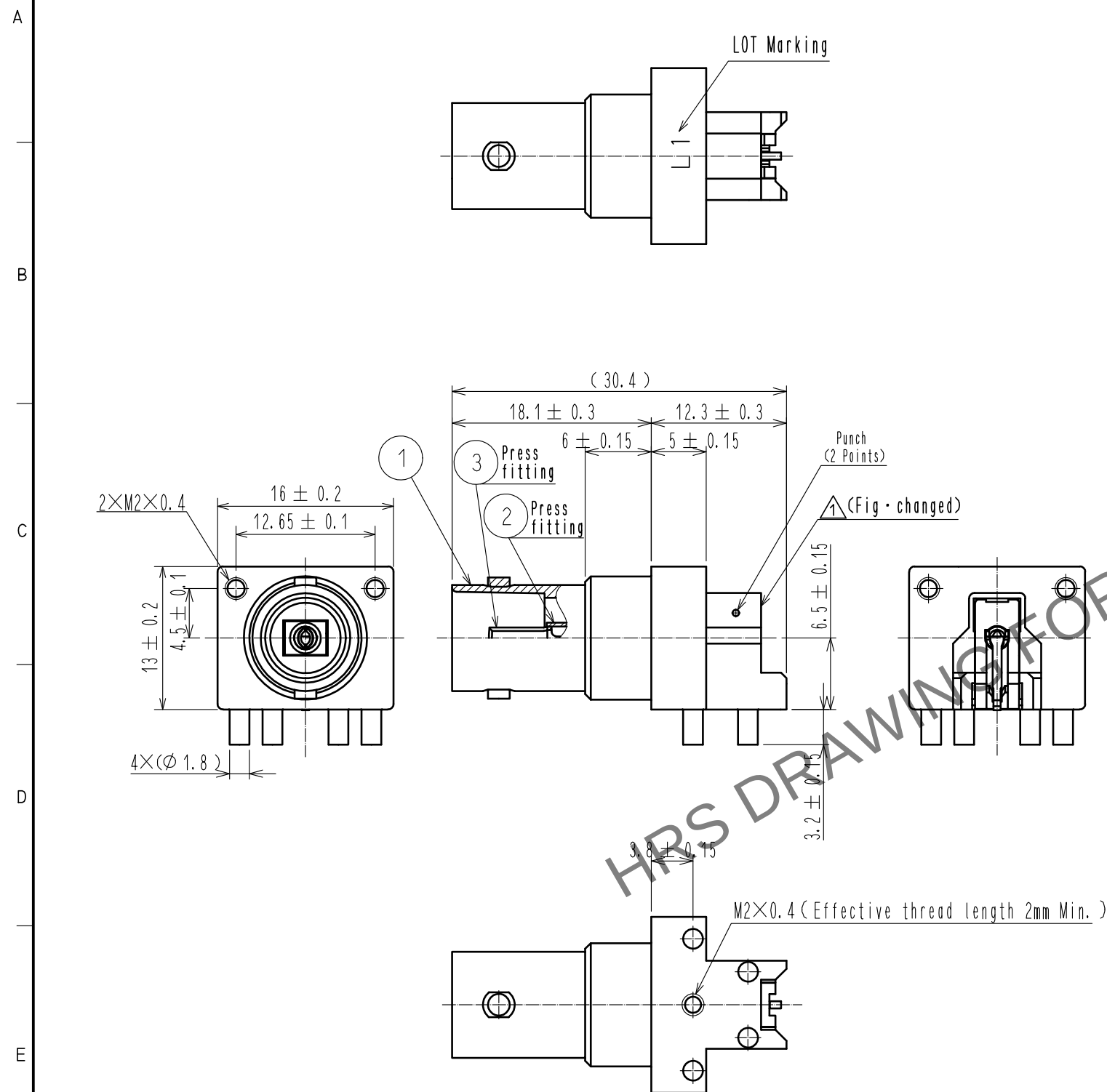
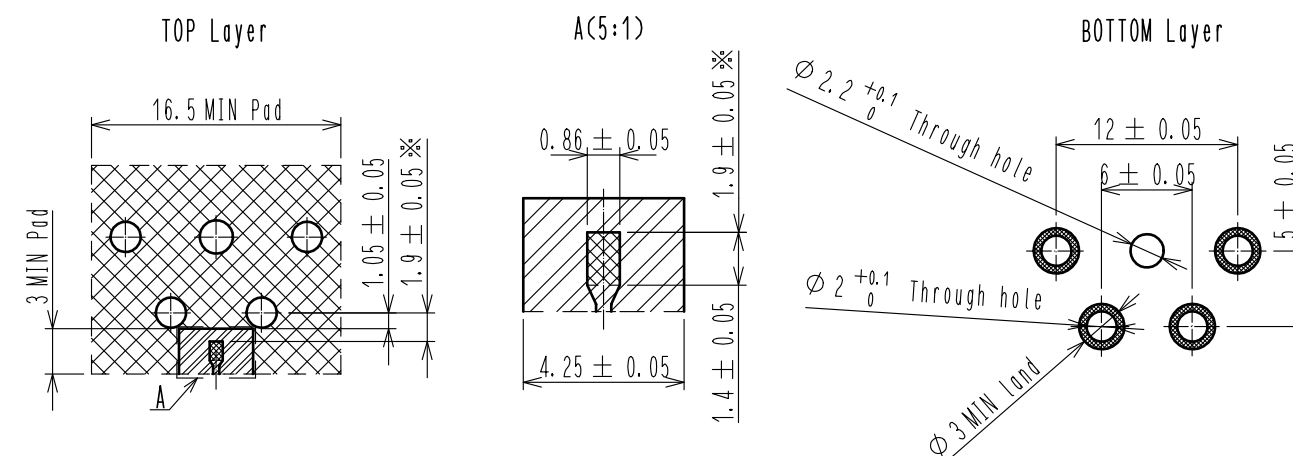




Recommended PCB Layout (t=1.6 FR4)

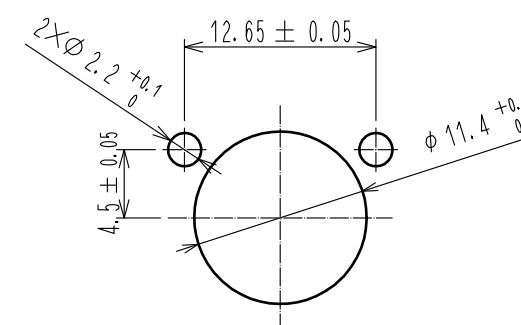
 Land/Pad Part

 Resist Part

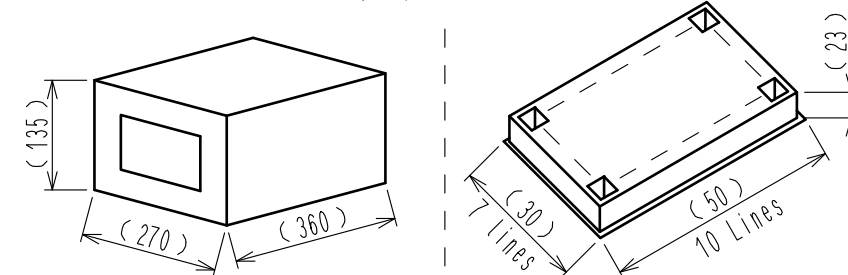


Note 1. ※ indicates duplicate dimension.
2. This pattern is an example of the FCB.
(thickness=1.6mm, material=FR4, layer thickness containing plating=0.035mm)

Reference: Panel Layout (Thickness 0.5~2.5mm)
Screw: M2×0.4



Packing specification(FREE) $\triangle$



Packing unit: max 250pcs/box
(Max 4 trays /box)

Max 70pcs/tray
(There is some fraction trays)

2	SPS							
1	ZINC ALLOY	NICKEL PLATING		3	BERYLLIUM COPPER	GOLD PLATING		
NO.	MATERIAL	FINISH . REMARKS			NO.	MATERIAL	FINISH . REMARKS	
UNITS mm		SCALE 2 : 1	COUNT  1	DESCRIPTION OF REVISIONS DIS-D-00001222		DESIGNED MA. SAEKI	CHECKED KY. SHIMIZU	DATE 16. 05. 3
 HIROSE ELECTRIC CO., LTD.		APPROVED : KY. SHIMIZU		16. 03. 04		DRAWING NO. EDC-368283-00-00		
		CHECKED : KY. SHIMIZU		16. 03. 04		PART NO. BNC(75)-PLR-PC-12G-1		
		DESIGNED : YI. FUNADA		16. 03. 04		CODE NO. CL302-0083-0-00		
		DRAWN : YI. FUNADA		16. 03. 04		 1/		